DCMTK - Feature #826

Create command line tools for encapsulating STL files in DICOM

2018-04-29 15:15 - Marco Eichelberg

Status: Closed Start date: 2018-04-29

Priority: Normal Due date: 2018-05-25

Assignee: Pedro Fernando Arizpe Gómez % Done: 0%

Category:ApplicationEstimated time:4:00 hours

Target version: 3.6.4

Module: Compiler:

Operating System:

Description

- Implement command line tools similar to pdf2dcm/dcm2pdf that allow the user to encapsulate STL files in DICOM (DICOM Supplement 205)
- Further 3D printing formats (X3D, VRML) are planned to be supported in DICOM and should also be implemented here.

History

#1 - 2018-05-02 15:20 - Pedro Fernando Arizpe Gómez

- Category set to Application
- Assignee set to Pedro Fernando Arizpe Gómez
- Target version set to 3.6.4

#2 - 2018-05-03 18:21 - Pedro Fernando Arizpe Gómez

- Due date set to 2018-05-09
- Status changed from New to Assigned
- Estimated time set to 4:00 h

#3 - 2018-05-17 12:21 - Pedro Fernando Arizpe Gómez

- Due date changed from 2018-05-09 to 2018-05-25

#4 - 2018-08-10 16:28 - Pedro Fernando Arizpe Gómez

- Status changed from Assigned to Closed

2025-09-06 1/1